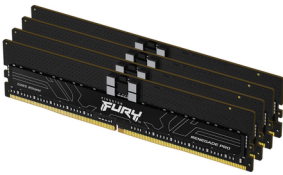




Kingston Technology FURY Renegade Pro módulo de memoria 64 GB 4 x 16 GB DDR5 ECC

Marca : Kingston Technology Familia de productos: FURY Código del producto: KF560R32RBK4-64

Nombre del producto : 64GB
6000MT/s DDR5 ECC Reg CL32
DIMM (Kits de 4) FURY Renegade
Pro XMP



64GB 6000MT/s DDR5 ECC Reg CL32 DIMM (Kits de 4) FURY Renegade Pro XMP

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Sobreaceleración con ECC

Mantiene la integridad de los datos trascendiendo los límites del rendimiento DDR5.

Mayor eficacia

Con el doble de bancos y de velocidades de ráfaga, satisface las demandas de los programas y aplicaciones más recientes con una mayor eficacia y menores latencias.

Homologación Intel® XMP 3,0

Seleccione alguno de los perfiles integrados para maximizar el rendimiento de la memoria con avanzadas temporizaciones, velocidades y tensiones preoptimizadas.

AMD EXPO (Extended Profiles for Overclocking)

Entre los módulos certificados se incluyen los perfiles Intel XMP 3.0, lo que facilita la compatibilidad con la plataforma que elijas.

Plug N Play**

Los módulos Kingston FURY Renegade Pro DDR5 RDIMM se sobreaceleran automáticamente hasta la velocidad de referencia más alta.

Features		Features	
Buffered memory type	Registered (buffered)	Cooling type	Heatsink
On-Die ECC	✓	Lead plating	Gold
CAS latency	32	JEDEC standard	✓
Internal memory *	64 GB	Operational conditions	
Memory layout (modules x size) *	4 x 16 GB	Operating temperature (T-T)	0 - 95 °C
Internal memory type *	DDR5	Storage temperature (T-T)	-55 - 100 °C
Memory data transfer rate	6000 MT/s	Technical details	
Component for *	PC/Server	Compliance certificates	RoHS
Memory form factor *	288-pin DIMM	Sustainability	
ECC *	✓	Doesn't contain	Halogen
Memory channels	Quad-channel	Weight & dimensions	
Memory ranking	1	Width	3.8 mm
Memory voltage	1.35 V	Depth	133.3 mm
Module configuration	2048M x 80	Height	31.2 mm
Row cycle time	48 ns	Weight	72.8 g
Refresh row cycle time	295 ns	Packaging data	
Row active time	32 ns	Package width	104.1 mm
Intel Extreme Memory Profile (XMP)	✓	Package depth	167.6 mm
Intel Extreme Memory Profile (XMP) version	3.0	Package height	35.6 mm
SPD profile	✓	Package weight	109.34 g
Programming power voltage (VPP)	1.8 V	Logistics data	
Country of origin	China, Taiwan	Master (outer) case width	207 mm
Product colour	Black	Master (outer) case length	469.9 mm
		Master (outer) case height	105.4 mm

Logistics data

Master (outer) case gross weight	1.45 kg
Products per master (outer) case	10 pc(s)



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